

Qualification

501-51057

Rev.E

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Title: CONNECTOR, SAS PLUG & Receptacle 15+7+7P

Product Specification:	108-51053 Rev G
Test Request No.:	T05 - 042 T06 – 090 (Test Group 6) T10 - 026 T11 – 016 (Test Group 1, 6 & 7)
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Qualification Test Report

1. Introduction

1.1 Purpose

Testing was performed on connector, SAS Plug and Receptacle 15+7+7P, so as to determine its conformance to the requirements of Product Specification 108-51053 Rev F.

1.2 Scope

This report covers the electrical, mechanical and environmental performance of SAS Plug and Receptacle 15+7+7P connector manufactured by Tyco Electronics Manufacturing (S) Pte Ltd.

1.3 Conclusion

The SAS Plug and Receptacle 15+7+7P connector meets all the electrical, mechanical and environmental requirements of Design Objectives 108-51053 Rev F.

1.4 Product Description

The SAS Plug and Receptacle 15+7+7P connector's housing is made of high temperature thermoplastics, glass filled. The contacts are made of Copper Alloy. Contacts were Gold plated at contact area and Nickel under-plate.

1.5 Test Samples

The test samples used for the qualification were randomly selected from production and the conditions of the parts used for each test were summarized in the table below:

Description	Part Number
SAS Plug, 15+7+7P	84958-x, 1735078-x, 1735183-x, 1735236-x, 1735099-x, 1735610-x, 1735902-x, 1735911-x, 2229630-x
SAS Receptacle, 15+7+7P	1735104-x, 1735105-x, 1735368-x, 1735164-x, 1735234-x



1.6 Qualification Test Sequence

Test Item	Test Group						
	1	2	3	4	5	6	7
Examination of Product	1,5	1,9	1,8	1,8	1,7	1,5	1,3
Low Level Contact Resistance	2,4	3,7	2,4, 6		4,6	2,4	
Insulation Resistance				2,6			
Dielectric Withstanding Voltage				3,7			
Temperature Rise			7				
Solderability							2
Soldering Heat Resistivity						3	
Mating Force		2					
Un-mating Force		8					
Durability	3	4(b)			2(b)		
Vibration (Random)		5					
Physical Shock		6					
Reseating (Manually plug/unplug 3 time)			5		5		
Humidity				5			
Temperature Life			3				
Thermal Shock				4			
Mixed Flowing Gas					3		

Note:

(b) Preconditioning, 50 cycles for the 500 durability cycle requirement. The mating and Un-mating cycle is at the maximum rate of 200 cycles per hour.



2. Summary of Testing

2.1 Examination of Product – All Groups

All samples were visually inspected under the scope and found to be free from any physical damages such as cracks, change of colour, corrosion etc.

2.2 Termination Resistance - TestGroup1,2,3,5& 6

All samples meet the requirement of 30 m Ω (maximum) initial Termination resistance. All samples meet the requirement of ΔR 15 m Ω (maximum) after test / environmental conditions.

Test Group (TG)	1 (Durability)		
Test condition	Initial	After Durability	
Sample size	5	5	
No. of	50	50	
measurement			
Overall average	15.77	16.23	
Overall minimum	13.27	13.79	
Overall maximum	17.58	19.42	
Overall Stdev	0.94	1.23	
∆R (Max)	-	3.88	

All Termination Resistance Measurement in $m\Omega$

Test Group (TG)	2 (Vibration & Physical shock)		
Test condition	Initial	After Physical	
		shock	
Sample size	5	5	
No. of	50	50	
measurement			
Overall average	15.76	15.73	
Overall minimum	13.57	13.58	
Overall maximum	17.70	17.78	
Overall Stdev	1.00	0.98	
∆R (Max)	-	1.35	



Test Group (TG)	3 (Temperature life)		
Test condition	Initial	After Temperature life	After Reseating
Sample size	5	5	5
No. of	50	50	50
measurement			
Overall average	15.91	16.33	15.98
Overall minimum	13.62	14.40	13.27
Overall maximum	19.12	19.08	17.83
Overall Stdev	1.38	1.16	0.87
∆R (Max)	-	3.85	3.98

Test Group (TG)	5 (Mixed Flowing Gas) - 7 day Un-mate, 7 days mated		
Test condition	initial	After MFG	After Reseating
Sample size	5	5	5
No. of	50	50	50
measurement			
Overall average	16.34	16.83	16.16
Overall minimum	13.76	14.24	14.21
Overall maximum	19.47	22.30	19.03
Overall Stdev	1.62	1.89	1.13
∆R (Max)	-	6.95	3.16

Test Group (TG)	5 (Mixed Flowing Gas) – 14 days mated		
Test condition	initial	After MFG	After Reseating
Sample size	5	5	5
No. of	50	50	50
measurement			
Overall average	16.13	16.00	15.83
Overall minimum	14.00	14.09	14.11
Overall maximum	19.41	18.25	17.51
Overall Stdev	1.19	1.06	0.89
∆R (Max)	-	2.34	2.16



Test Group (TG)	6 (Soldering Heat Resistivity)		
Test condition	Initial	After soldering heat resistivity	
Sample size	5	5	
No. of	50	50	
measurement			
Overall average	16.19	15.41	
Overall minimum	13.31	13.23	
Overall maximum	18.63	17.97	
Overall Stdev	1.53	1.08	
∆R (Max)	-	2.20	

2.3 Insulation Resistance – Test Group 4

All insulation resistance readings between adjacent contacts of connector were greater than 1000 M (initial).

Test Group (TG)	4 (Thermal shock & Humidity)	
Test condition	Initial After Humidi	
Sample size	5	5
No. of	50	50
measurement		
Overall average	3.94E+14	5.71E+13
Overall minimum	4.17E+13	1.11E+12
Overall maximum	9.09E+14	1.14E+14

2.4 Dielectric Withstanding Voltage – Test Group 4

No dielectric breakdown or flashover or leakage of current greater than 0.5mA occurred when a test voltage of 500 VDC was applied between adjacent contacts of connector.

2.5 Vibration & Physical Shock - Test Group 2

No Sample failed the electrical discontinuity



2.6 Mate/Un-mate & Durability Force – Test Group 2

The Mating force meets the requirement of 2.5kgf (Max), for initial & after 500 cycle of durability. The Un-mating force meets the requirement of 0.5kgf (Min), for initial & after 500 cycle of durability.

Test condition	1 st Cycle	Final
	Mate	Un-mate
Sample size	5	5
No. of	5	5
measurement		
Overall average	0.816	0.686
Overall minimum	0.723	0.536
Overall maximum	0.859	0.772
Overall Stdev	0.056	0.102

2.7 Solderability – Test Group 7

All contact leads showed more than 95% solder coverage with no voids and pins hole observed.

2.8 Resistance to Soldering Heat – Test Group 6

No physical damage was observed after resistance to soldering heat.

2.9 Temperature Rise – Test Group 3

Temperature rise meet the requirement of less than 30 °C.

Test Group(TG)	3
Sample size	5
No of measurements	45
Average	9.30
Minimum	3.60
Maximum	14.53

2.10 Visual Inspection – All Test Groups

No physical damage or loose contacts were observed before and after Durability, Mechanical & Environmental test.



3 Test Methods

3.1 Examination of Products

Samples were physically examined under the microscope before and after each test conditions for any physical damage or abnormalities on housing and contacts.

3.2 Insulation Resistance

Insulation resistance was measured between adjacent contacts of connector, using a test voltage of 500 VDC. Reading was recorded after 1 minute.

As per EIA-364-21

3.3 Dielectric Withstanding Voltage

A test potential of 500 VDC was applied between adjacent contacts of connector. This potential was held for 1 minute with a current leakage not greater than 0.5mA.

As per EIA-364-20, Method B

3.4 Contact/Termination Resistance

Measurements shall be made on mated connector, at a voltage of 20mv max open circuit at a current of 100mA.

As per EIA-364-23

3.5 Durability

Subject connector to 500 cycles of repeated mate and Un-mate. With an operation speed of 200 cycle per hour max.

As per EIA-364-09

3.6 Thermal Shock

Subjected mated connectors to temperature -55°C to +85°C for 10 cycles, each temperature dwell time 30 minutes.

As per EIA-364-32, Condition I

3.7 Vibration (Random)

Subject mated connectors for 1 hour in each of 3 mutually perpendicular planes. Frequency of 20 \sim 500Hz with 3.10 g's RMS.

As per EIA-364-28, Condition VII, Letter D.



3.8 Physical Shock Subject mated connector to 50Gs half sine pulses of 11ms duration along the 3 mutually perpendicular planes.

As per EIA-364-27, Condition A

3.9 Temperature Life

Subject mated connector to 85°C for 500 hours. As per EIA 364-17, Method A, Condition III

3.10 Mating Force

Mate connector assembly at a rate of 25mm per minute. As per EIA-364-13

3.11 Un-mating Force

Un-mate connector assembly at a rate 25mm per minute. As per EIA-364-13

3.12 Solderability

Immerse solderable portion of contact in molten solder at $245\pm2^{\circ}$ C for 5 seconds. Tyco 109-11-11

3.13 Resistance to Soldering Heat

Test connector EIA-364-56B, Procedure 6, Level #4.

3.14 Temperature Rise

Wire contact P1, P2, P8 & P9 in parallel for power. Wire contact P4, P5, P6, P10 & P12 in parallel for return.

Apply 6A total DC current to parallel contacts P1, P2, P8 & P9 and return from parallel contact P4, P5, P10 & P12.

3.15 Mixed Flowing Gas

Expose $\frac{1}{2}$ of the un-mated samples for 10 days and then mated for 4 additional days. The other $\frac{1}{2}$ of the samples are exposed mated for full 14 days.

As per EIA-364-65, Class 2A.



3.16 Reseating

Subject connectors to 3 manual mate/un-mate cycles. No lubrication to be used.

3.17 Humidity

Subject mated connector to 96 hours at 40°C with 90~95%RH. As per EIA-364-31, Method II, Condition A.